

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	32	((porous adj mold)same (male and female))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:41
L2	46	((molecular adj bond\$3) same (assembled same substrates))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:51
L3	5	2 and @ad<"20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:51
L4	13075	(treat\$3 same (bond\$3 same substrates))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:12
L5	7593	4 and @ad<"20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:12
L6	1803	438/455.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:37
L7	23	6 and (((attache\$2 bond \$3) with (wafer substrate sheet)) same (curve))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:37
L8	13	7 and @ad<"20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:38
L9	2143	(((attache\$2 bond\$3) with (wafer substrate sheet)) same (curve)) and (channels hold\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:38
L10	2366	(((attache\$2 bond\$3) with (wafer substrate sheet)) same (curve)) and (channels hold\$3 sanme wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:39
L11	1118	(((attache\$2 bond\$3) with (wafer substrate sheet)) same (curve)) and (channels hold\$3 same (wafer substrate))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 12:39
S1	104	("20020025604" "20020153563" "20020185684" "20030077885" "20030134489" "20030162367" "20030199105" "20040144487" "4028149" "4254590" "5242863" "5300788" "5374564" "5400458" "5405802" "5559043" "5811348" "5854123" "5877070" "5909627" "5920764" "5953622"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:16

		"5966620" "5993677" "5994207" "6013563" "6020252" "6048411" "6054370" "6071795" "6103599" "6127199" "6146979" "6150239" "6190998" "6225190" "6225192" "6271101" "6303468" "6323108" "6323109" "6346458" "6362077" "6513564" "6534380" "6593212" "6607969" "6727549" "6756286" "6770507" "6946365").PN.				
S2	50	S1 and (stress and force or pressure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:20
S3	524001	S2 and (assembl\$3 or bond \$3 or connect\$3) wiht (wafer\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:18
S4	28	S2 and (assembl\$3 or bond \$3 or connect\$3) with (wafer\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:19
S5	1	S4 and (Concave and convex)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:27
S6	21109	(stress and force or pressure)same (bond\$3 or assembl\$3 or connect\$3) same wafer\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:21
S7	86572	(stress and force or pressure)same (bond\$3 or assembl\$3 or connect\$3) same (wafer\$1 or substrate\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:21
S8	3262	S7 and (Concave and convex)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/11/22 17:27
S9	31	("4676841" "5250460" "5346841" "5374564" "5494835" "5510277" "5559043" "5714395" "5863830" "5863832"). PN. OR ("6225190"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:26

S10	111	("4448636" "4774194" "4883561" "5374564" "5376580" "5413951" "5559043" "5836325" "5837561").PN. OR ("6071795").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:29
S11	9	("2241478" "2709324" "3685216" "3693301" "3833230" "3861089" "3889431").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:32
S12	13	("2241478" "2709324" "3685216" "3693301" "3833230" "3861089" "3889431").PN. OR ("4254590").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:32
S13	3083	((wafer substrate sheet same (bond\$3 same stress)) and (curve))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:34
S14	0	S13 and ad@20031208	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:36
S15	3083	S13 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:36
S16	3083	S13 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:36
S17	1586	S13 and @ad< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:37
S18	188	S17 and ((attache\$2 bond \$3) with (wafer substrate sheet)) same (curve))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:39
S19	2	("2004/0067621").URPN.	USPAT	OR	ON	2008/11/18 14:41
S20	10	("2003/0134488").URPN.	USPAT	OR	ON	2008/11/18 14:51
S21	11	("20020001046" "20030062830" "20030134488" "20030162312" "20030184704" "20040135160" "4271584" "5650363" "5652930" "6197418" "7113661").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:52
S22	15	("4717790" "4735909" "5158645" "5393711" "5400548" "5494549").PN. OR ("5650363").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/18 14:54

S23	2	"20030134488".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/20 07:17
S24	675	(mold same (female and male and porous))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/20 09:41
S25	592	S24 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 09:41
S26	2	S25 and (((attache\$2 bond \$3) with (wafer substrate sheet))) same (curve))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 09:42
S27	675	(mold same (female and male and porous))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/20 09:43
S28	318	(mold same (female same male same porous))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/20 09:43
S29	246	S28 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 09:44
S30	40	((porous adj mold) same ((male and female) same mold))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/20 09:45
S31	32	S30 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 09:45
S32	34	porous adj mol	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:31
S33	1113	porous adj mold	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:31
S34	32	((porous adj mold)same (male and female))	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:31
S35	32	S34 and ad@< "20031208"	US-PGPUB; USPAT; USOCR	OR	ON	2008/11/20 11:32

11/20/2008 12:48:35 PM

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